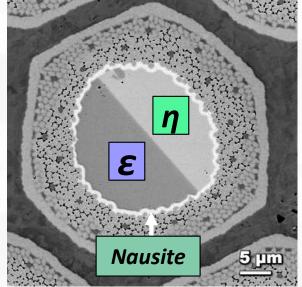
Significant improvement of J_c in small D_s RRP[®] wires through heat treatment changes and phase control Using Nausite to our advantage

<u>Charlie Sanabria¹</u>, Michael Field², P. J. Lee¹, Hanping Miao², D. C. Larbalestier¹ and Jeffrey Parrell²



 ¹Applied Superconductivity Center, NHMFL, Florida State University, Tallahassee, FL 32310, USA
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07008, USA



The Business of Science*



Outline

The 'big picture'

- Current RRP[®] limitations
- Hi-Lumi and FCC demands

Heat Treatment "revelation"

- Ian Pong, et. al. (2013)
- The "Nausite mem
- The Good, the Bad

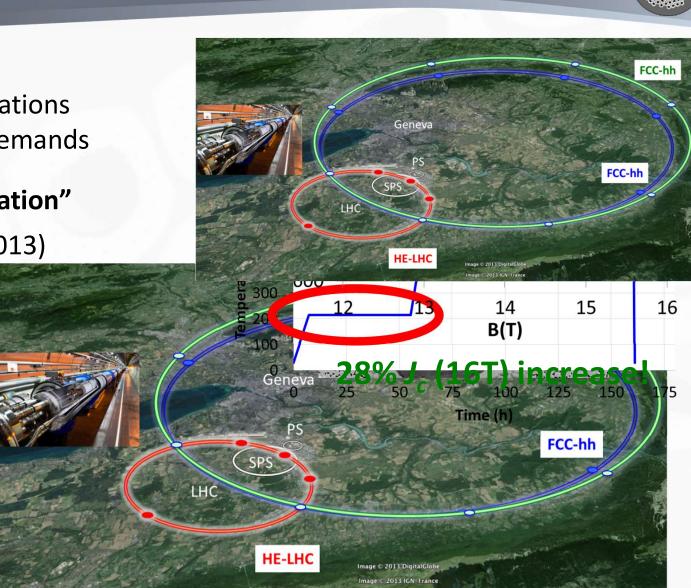
Key Findings

- The 215°C dwell is
- Nausite growth is
- Cu diffusion is wea

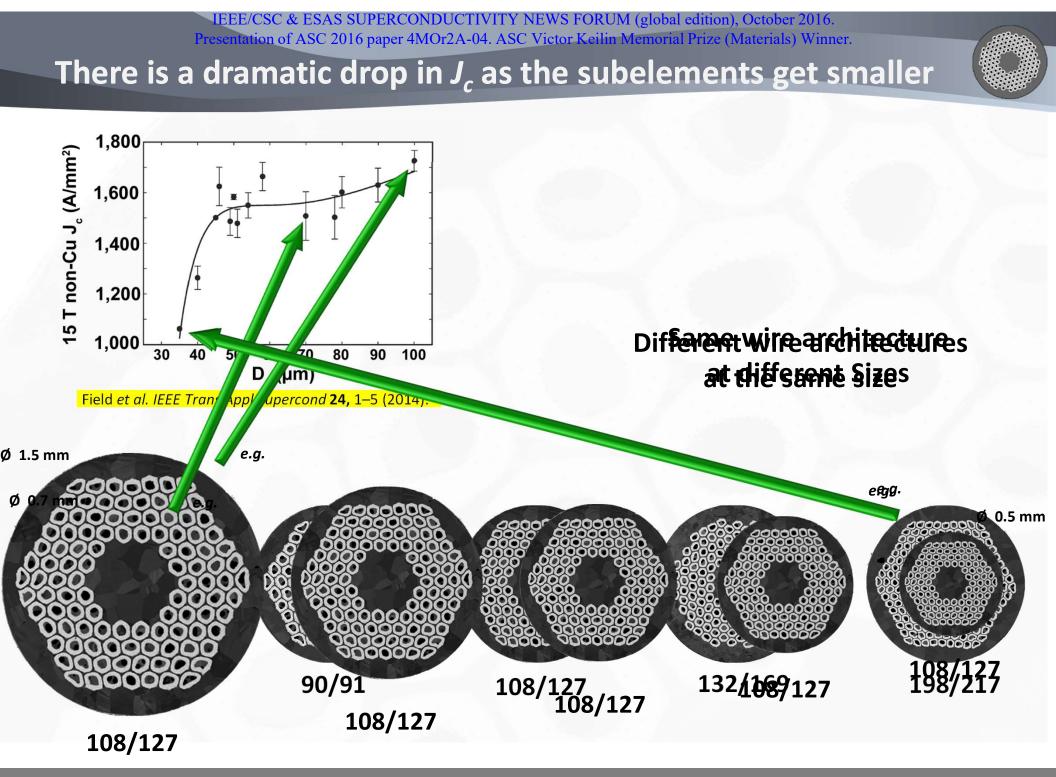
Conclusion

- Promoting Cu diffusion while inhibiting Nausite growth capiding seal Bottura
- Our new heat treatment improved J_c (16 T) in small D_s wires by 28% (preserving RRR)

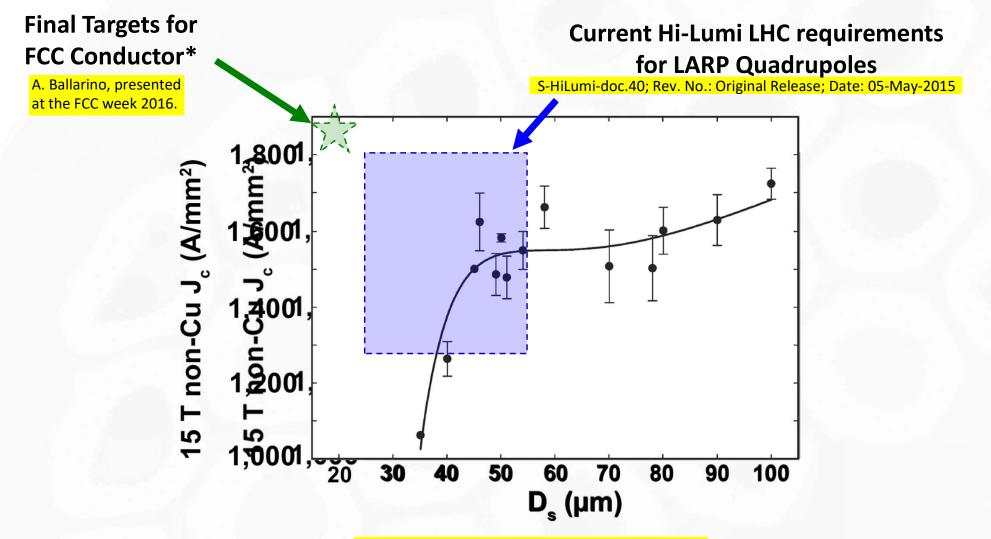








LHC requirements



Field *et al. IEEE Trans Appl Supercond* **24,** 1–5 (2014).

* Values presented at 16 T (1500 A/mm²) Kramer extrapolation to 15 T = 1865 A/mm²

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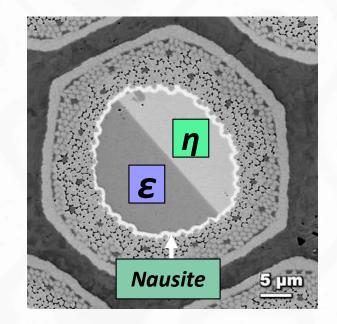
- Ian Pong, et. al. (2013)
- The "Nausite membrane"
- The Good, the Bad and the Ugly

Key Findings

- The 215°C dwell is useless
- Nausite growth is strongly dependent on temperature
- Cu diffusion is weakly dependent on temperature

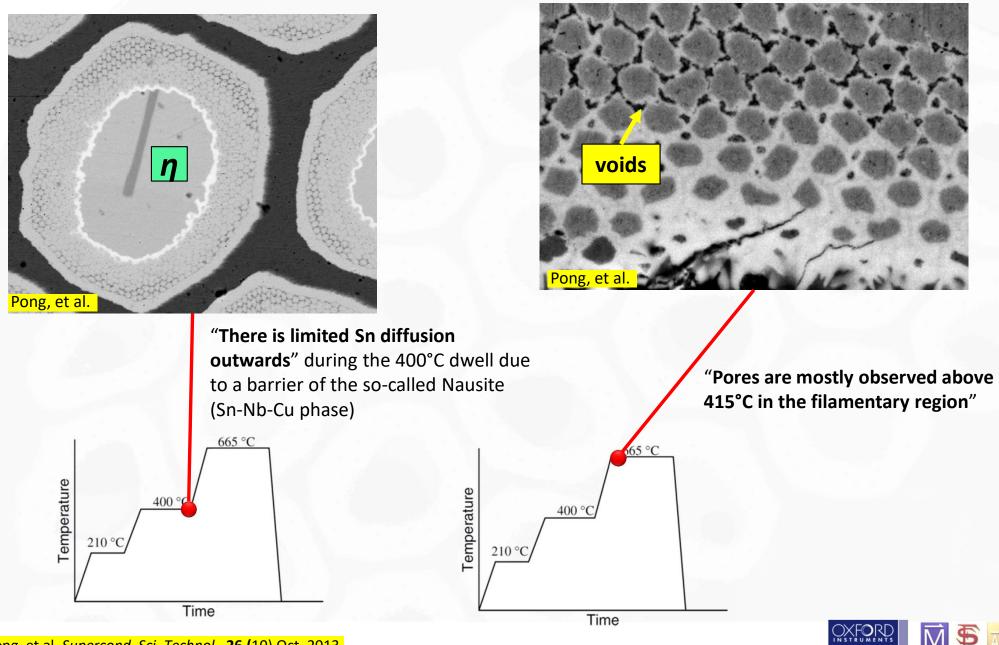
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- Promoting Cu diffusion while inhibiting Nausite growth can increase J_c
- Our new heat treatment improved J_c (16 T) in small D_s wires by 28% (preserving RRR)

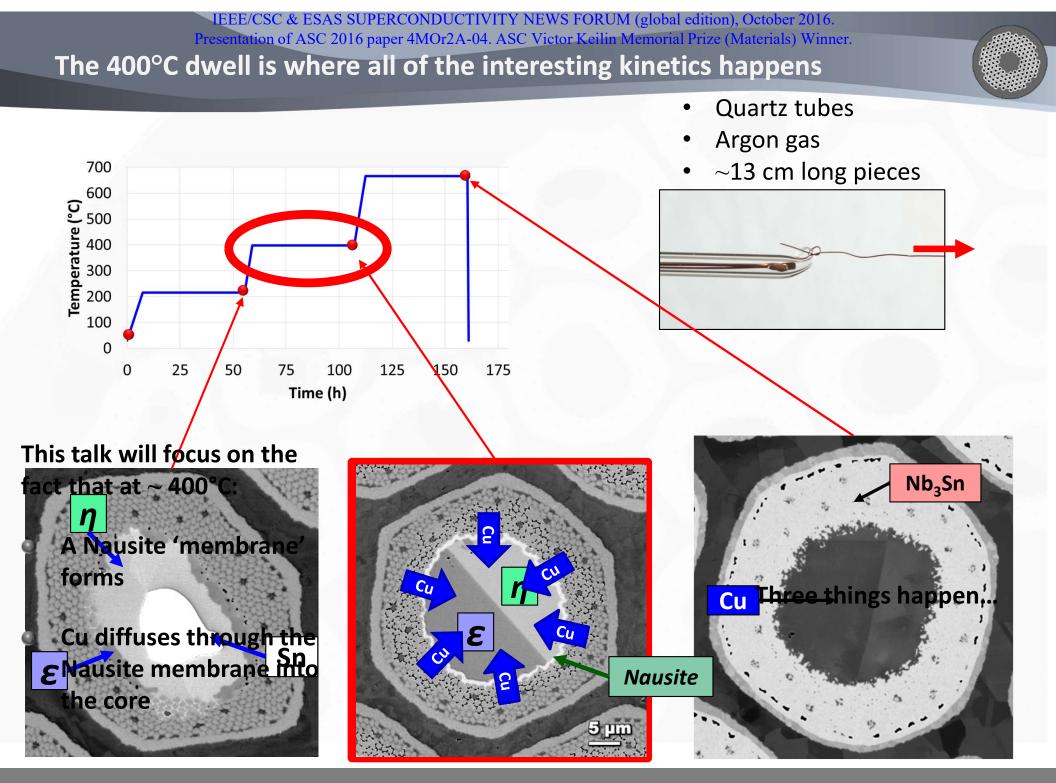




IEEE/CSC & ESAS SUPERCONDUCTIVITY NEWS FORUM (global edition), October 2016. Presentation of ASC 2016 paper 4MOr2A-04. ASC Victor Keilin Memorial Prize (Materials) Winner. "There is limited Sn diffusion outwards" during the 400°C dwell – Pong, et. al. (2013)



Slide 6 of 17









Cu diffusion into the core



Nausite growth



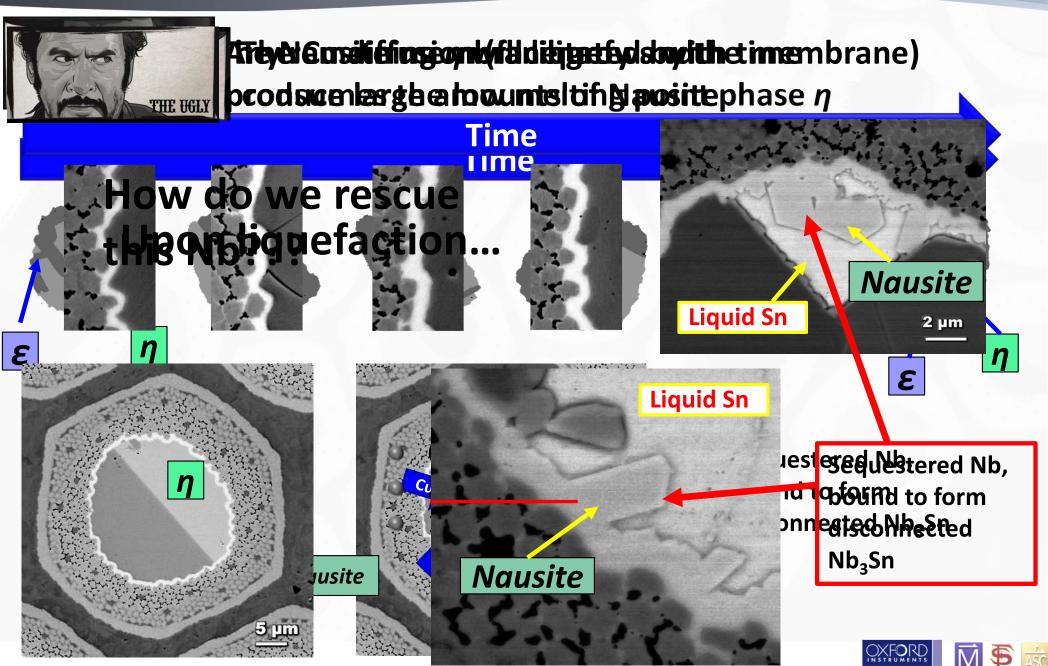
Liquefaction of η

Drawings: © Orlando Aquije 2008 atixyector.deviantart.com





The Good, the Bad and the Ugly



് <u>Slide</u>

9 of 17

Outline

The 'big picture'

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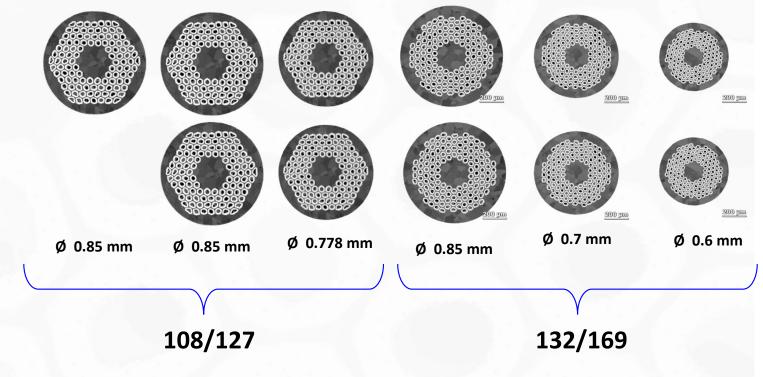
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Slide 10 of 17

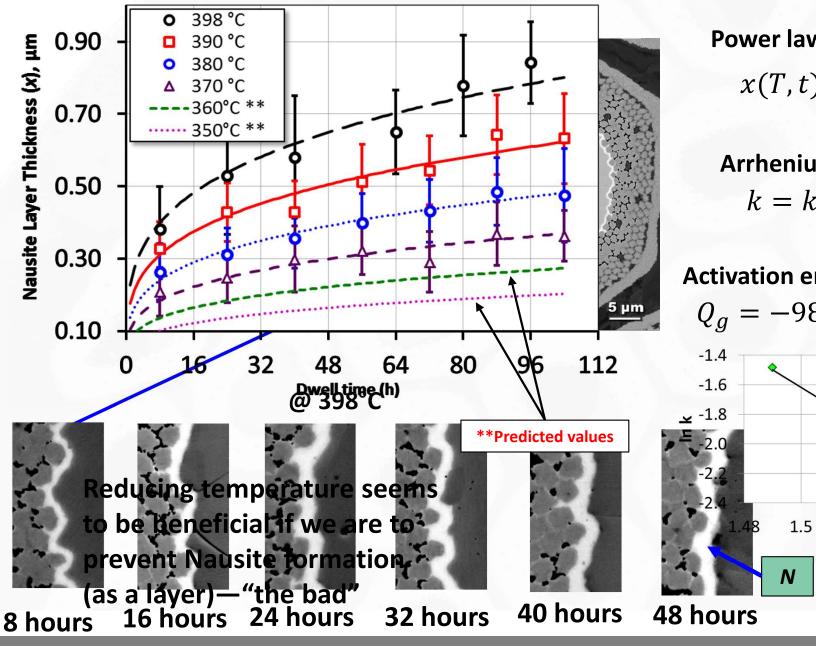
IEEE/CSC & ESAS SUPERCONDUCTIVITY NEWS FORUM (global edition), October 2016. Presentation of ASC 2016 paper 4MOr2A-04. ASC Victor Keilin Memorial Prize (Materials) Winner. The 215°C dwell is useless, and it can be skipped without affecting strand properties





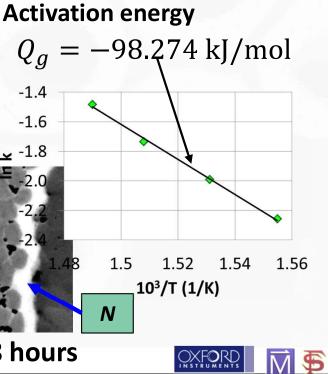
IEEE/CSC & ESAS SUPERCONDUCTIVITY NEWS FORUM (global edition), October 2016. Presentation of ASC 2016 paper 4MOr2A-04. ASC Victor Keilin Memorial Prize (Materials) Winner.

Nausite growth is strongly dependent on temperature



Power law growth $x(T,t) = kt^{0.27}$

Arrhenius $k = k^0 e^{\left(-\frac{Q_g}{RT}\right)}$

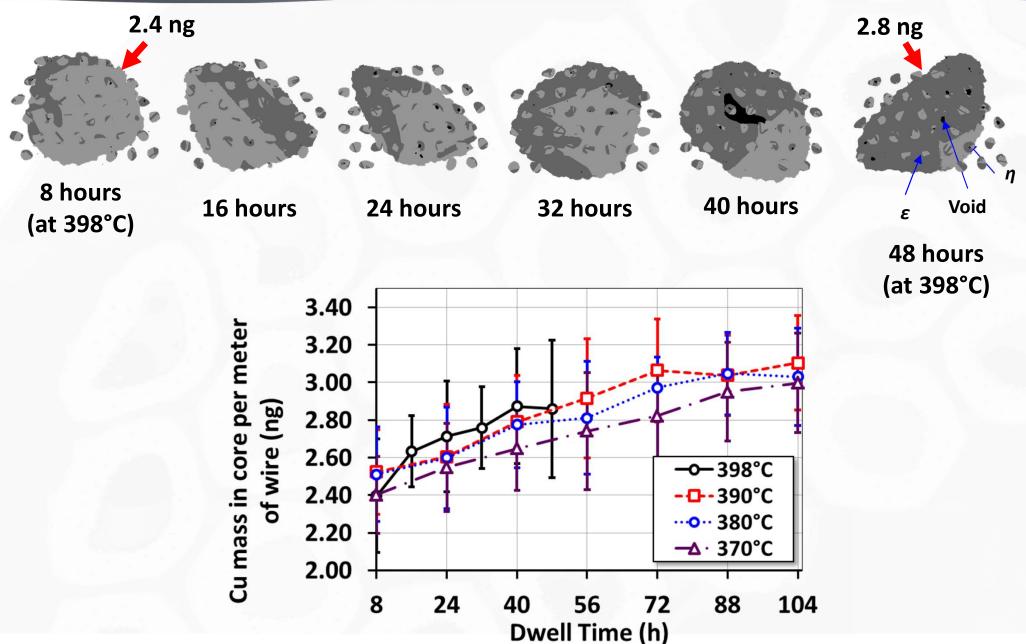


Slide 12 of 17

IEEE/CSC & ESAS SUPERCONDUCTIVITY NEWS FORUM (global edition), October 2016. Presentation of ASC 2016 paper 4MOr2A-04. ASC Victor Keilin Memorial Prize (Materials) Winner.

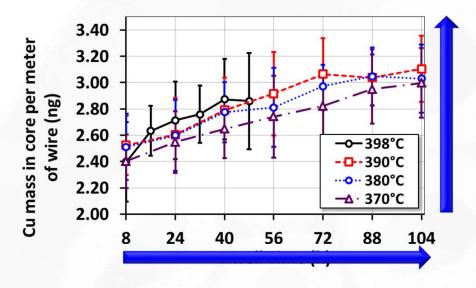
Cu diffusion to the core is weakly dependent on temperature



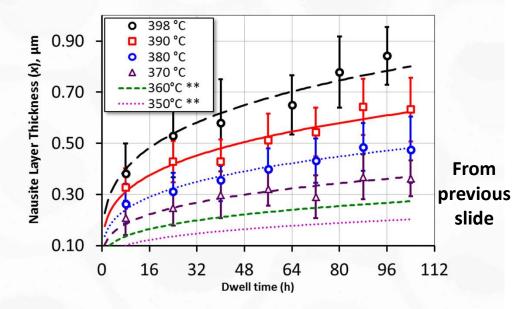


IEEE/CSC & ESAS SUPERCONDUCTIVITY NEWS FORUM (global edition), October 2016. Presentation of ASC 2016 paper 4MOr2A-04. ASC Victor Keilin Memorial Prize (Materials) Winner. Longer heat treatments at lower temperatures draw more Cu in and inhibit Nausite Growth

"The Good" is not affected by lower temperatures



"The Bad" is slowed down significantly by lower temperatures



All we have to do to take care of "The Ugly" is let this run for a long time...

...so more Cu gets drawn in



Slide 14 of 17

3000

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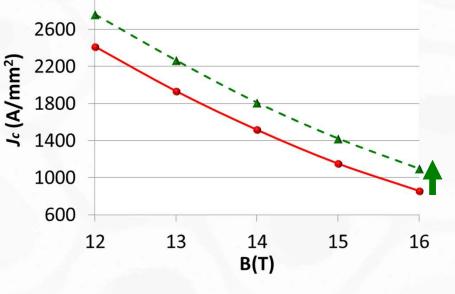
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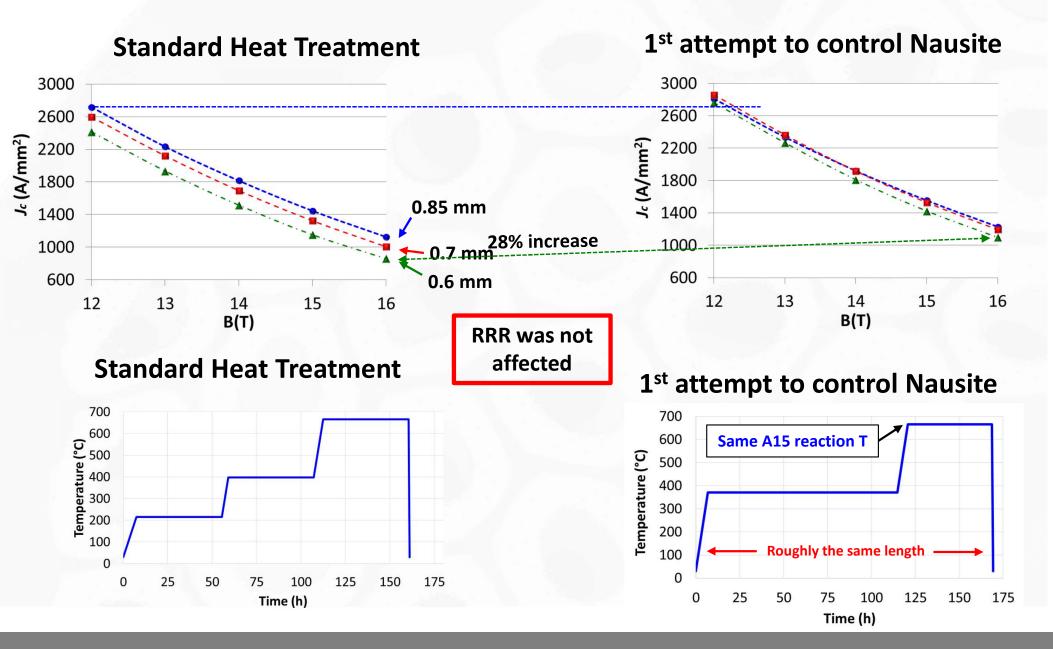


28% J_c (16T) increase!

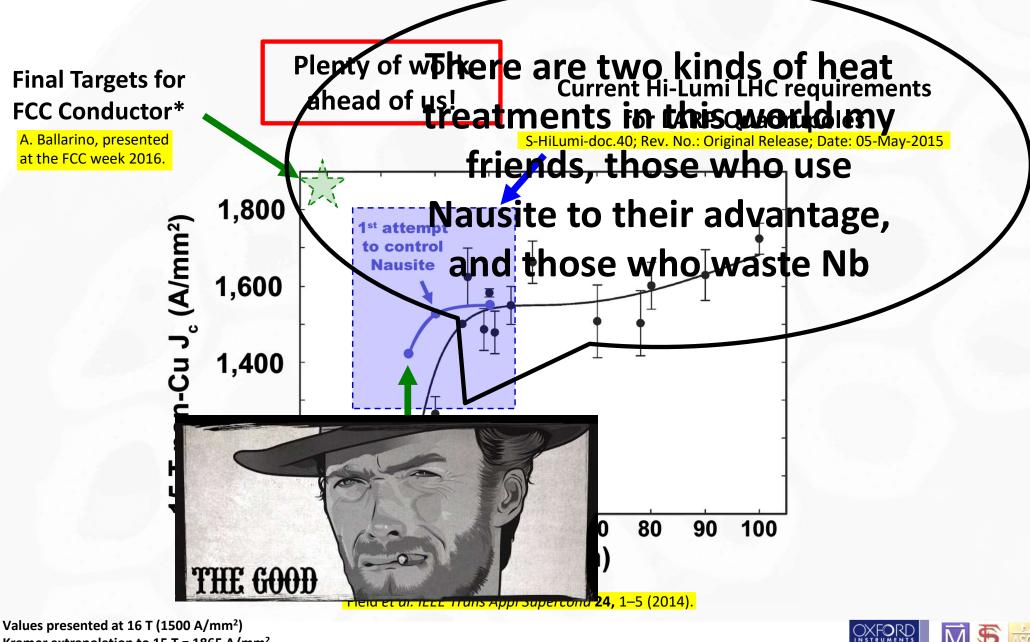


IEEE/CSC & ESAS SUPERCONDUCTIVITY NEWS FORUM (global edition), October 2016. Presentation of ASC 2016 paper 4MOr2A-04. ASC Victor Keilin Memorial Prize (Materials) Winner.

Promoting Cu diffusion while inhibiting Nausite growth can increase J_c

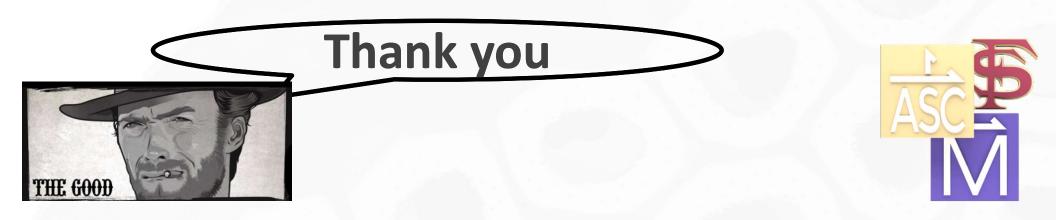


Back to the (sobering) 'big picture'



* Values presented at 16 T (1500 A/mm²) Kramer extrapolation to $15 T = 1865 A/mm^2$





Special thanks to Arup Ghosh (BNK), Ian Pong (LBNL), Dan Dietderich (LBNL), and Lance Cooley (Fermi Lab) for fruitful discussions.

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